

## AMENDMENTS TO SPECIFICATION

Please amend the following paragraphs as indicated by the marked-up versions set forth below.:

Page 5, line 22 to Page 6, line 1:

The circuit space converter **20** comprises a ~~multiplayer~~multilayer ceramic substrate (MLC) **21**, which has multiple layers of circuits arranged therein, ~~and contacts~~ **65** disposed at the top side, and ~~contacts~~ **66** disposed at the bottom sides side, ~~the contacts~~ **65,66** being disposed at predetermined locations and respectively electrically connected to the circuits. Subject to the arrangement of the multiple layers of circuits, the density of the contacts **65** at the top side is higher than the density of contacts **66** at the bottom side.

Page 6, lines 4-8:

Step I: Formation of probe holders **22** on the top of the MLC **21**. As shown in FIG. 6, probe holders **22** are formed of high hardness, for example, Ni-Co on the topside of the MLC **21** at the respective circuit contacts **65** by means of LIGA (Lithography process), and then a bonding layer **23** is formed of tin lead alloy on the probe holders **22** by means of electroplating for the bonding of the probes **10**.